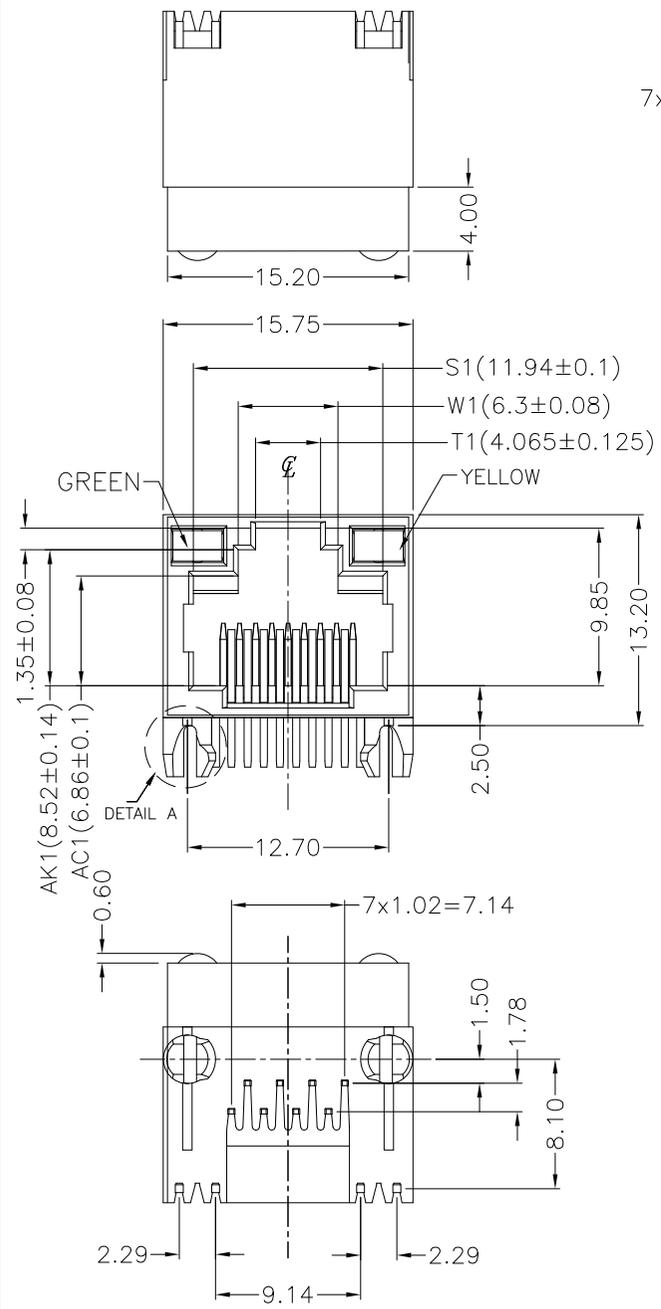
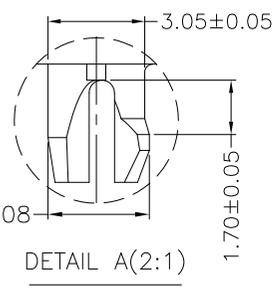
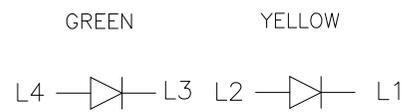
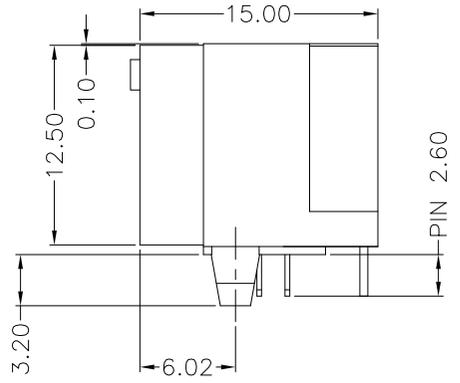
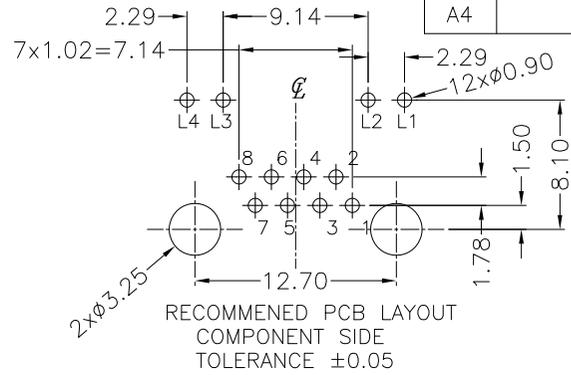


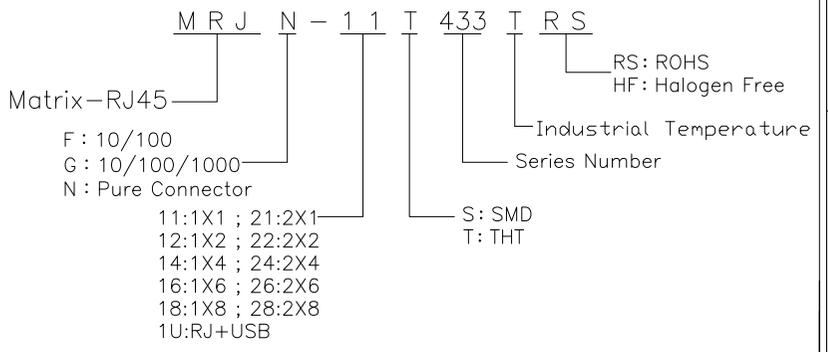
GP Component

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2016/01/22	Phebe Su
A1			Change housing type	2016/01/25	Phebe Su
A2			Change housing type	2016/01/28	Phebe Su
A3			Change pin length and housing type	2016/01/29	Phebe Su
A4			Sealing on the back side of Housing	2018/08/22	Phebe Su



- NOTES:
- MATERIALS:
HOUSING: PA66, UL94V-0, YELLOW(114C).
CONTACTS: T=0.30 mm PHOSPHOR BRONZE,
50u" NICKEL UNDERPLATE
100u" TIN ON SOLDER TAIL
GOLD 3u" ON CONTACT AREA.
 - OPERATING TEMPERATURE: -40°C ~ +85°C
 - LED SPEC:
FORWARD VOLTAGE: 1.8~2.4V
REVERSE CURRENT: 5uA MAX
PEAK WAVE LENGTH:
GREEN: 565~575nm YELLOW: 585~590nm
 - JACK CAVITY MEET IEC60603-7 AND FCC PART 68, SUBPART F

ORDER INFORMATION :



NO	VARIETY	QTY	MATERIAL	REMARK
Matrix Electronics Co.,Ltd				
TOLERANCE: X.X ±0.30 X.XX ±0.20 X.XXX ±0.10 ANGLE: ±3°		DESIGN BY : Phebe Su	DATE : 2018/08/22	PART NAME: RJ45 1x1 TAB UP PCB JACK
APPROVED BY1: Richard Hsieh		DATE : 2018/08/22	MOLD NO.	NA
APPROVED BY2: Richard Hsieh		DATE : 2018/08/22	DRAW NO.	
SCALE:1:1	SIZE:A4		SHEET NO.	1 OF 1